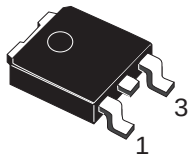
STD100NH03L

N-CHANNEL 30V - 0.005 Ω - 60A DPAK
STripFET™ III POWER MOSFET

TYPE	V_{DSS}	$R_{DS(on)}$	I_D
STD100NH03L	30 V	< 0.0055 Ω	60 A(2)

- TYPICAL R_{DS}(on) = 0.005 Ω @ 10 V
- $R_{DS(ON)}$ * Qg INDUSTRY's BENCHMARK
- CONDUCTION LOSSES REDUCED
- SWITCHING LOSSES REDUCED
- LOW THRESHOLD DEVICE
- SURFACE-MOUNTING DPAK (TO-252) POWER PACKAGE IN TAPE & REEL (SUFFIX "T4")



DPAK
TO-252
(Suffix "T4")

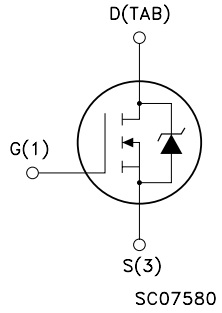
DESCRIPTION

The **STD100NH03L** utilizes the latest advanced design rules of ST's proprietary STripFET™ technology. This is suitable fot the most demanding DC-DC converter application where high efficiency is to be achieved.

APPLICATIONS

- SPECIFICALLY DESIGNED AND OPTIMISED FOR HIGH EFFICIENCY DC/DC CONVERTES

INTERNAL SCHEMATIC DIAGRAM



Ordering Information

SALES TYPE	MARKING	PACKAGE	PACKAGING
STD100NH03LT4	D100NH03L	TO-252	TAPE & REEL

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source Voltage (V_{GS} = 0)	30	V
V_{DGR}	Drain-gate Voltage (R_{GS} = 20 kΩ)	30	V
V_{GS}	Gate- source Voltage	± 20	V
I_D(2)	Drain Current (continuous) at T_C = 25°C	60	A
I_D(2)	Drain Current (continuous) at T_C = 100°C	60	A
I_{DM}(3)	Drain Current (pulsed)	240	A
P_{tot}	Total Dissipation at T_C = 25°C	100	W
	Derating Factor	0.66	W/°C
E_{AS} (4)	Single Pulse Avalanche Energy	700	mJ
T_{stg}	Storage Temperature	-55 to 175	°C
T_j	Max. Operating Junction Temperature		

THERMAL DATA

Rthj-case	Thermal Resistance Junction-case	Max	1.5	°C/W
Rthj-amb	Thermal Resistance Junction-ambient	Max	100	°C/W
Rthj-pcb	Thermal Resistance Junction-pcb(#)	Max	43	°C/W
T_l	Maximum Lead Temperature For Soldering Purpose		275	°C

(#) When Mounted on 1 inch^2 FR-4 board, 2 oz of Cu.

ELECTRICAL CHARACTERISTICS (T_{CASE} = 25 °C UNLESS OTHERWISE SPECIFIED)

OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source Breakdown Voltage	I_D = 250 µA, V_{GS} = 0	30			V
I_{DSS}	Zero Gate Voltage Drain Current (V_{GS} = 0)	V_{DS} = Max Rating V_{DS} = Max Rating T_C = 125°C			1 10	µA µA
I_{GSS}	Gate-body Leakage Current (V_{DS} = 0)	V_{GS} = ± 20V			±100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS} I_D = 250 µA	1	1.8	2.5	V
$R_{DS(on)}$	Static Drain-source On Resistance	V_{GS} = 10 V I_D = 30 A V_{GS} = 5 V I_D = 30 A		0.005 0.0060	0.0055 0.0105	Ω Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g_{fs} (5)	Forward Transconductance	V_{DS} = 10 V I_D = 30 A		40		S
C_{iss} C_{oss} C_{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V_{DS} = 15V f = 1 MHz V_{GS} = 0		4100 680 70		pF pF pF
R_G	Gate Input Resistance	f = 1 MHz Gate DC Bias = 0 Test Signal Level = 20 mV Open Drain		1.3		Ω

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$ t_r	Turn-on Delay Time Rise Time	V_{DD} = 15 V I_D = 30 A R_G = 4.7 Ω V_{GS} = 10 V (Resistive Load, Figure 3)		16 95		ns ns
Q_g Q_{gs} Q_{gd}	Total Gate Charge Source Gate Charge Gate-Drain Charge	V_{DD}= 15 V I_D= 60 A V_{GS}= 10 V		57 11.8 7.3	77	nC nC nC
Q_{oss}(6)	Output Charge	V_{DS}= 16 V V_{GS}= 0 V		27		nC
Q_{gls}(7)	Third-quadrant Gate Charge	V_{DS}< 0 V V_{GS}= 10 V		55		nC

SWITCHING OFF

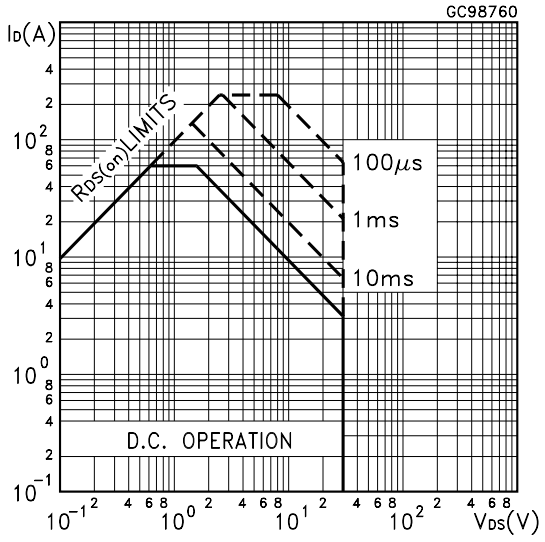
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(off)}$ t_f	Turn-off Delay Time Fall Time	V_{DD} = 15 V I_D = 30 A R_G = 4.7Ω, V_{GS} = 10 V (Resistive Load, Figure 3)		48 23		ns ns

SOURCE DRAIN DIODE

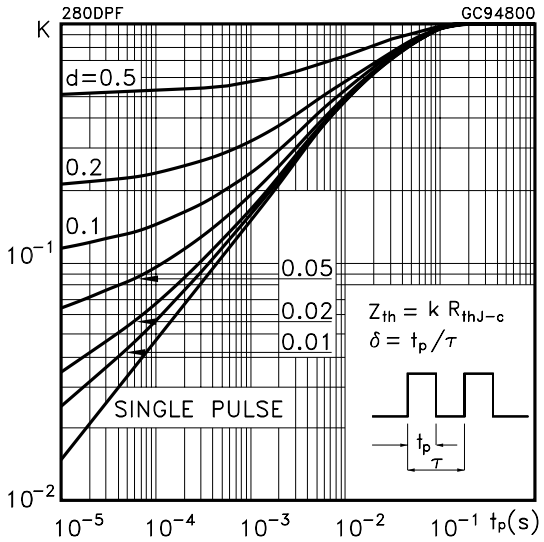
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{SD} I_{SDM}	Source-drain Current Source-drain Current (pulsed)				60 240	A A
V_{SD} (5)	Forward On Voltage	I_{SD} = 30 A V_{GS} = 0			1.4	V
t_{rr} Q_{rr} I_{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	I_{SD} = 60 A di/dt = 100A/µs V_{DD} = 30 V T_j = 150°C (see test circuit, Figure 5)		46 64 2.8	62 86	ns nC A

(2) Value limited by wire bonding
(3) Pulse width limited by safe operating area.
(4) Starting T_j = 25 °C, I_D = 30A, V_{DD} = 15V
(5) Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %.
(6) $Q_{oss} = C_{oss}*\Delta V_{in}$, $C_{oss} = C_{gd} + C_{ds}$. See Appendix A
(7) Gate charge for synchronous operation

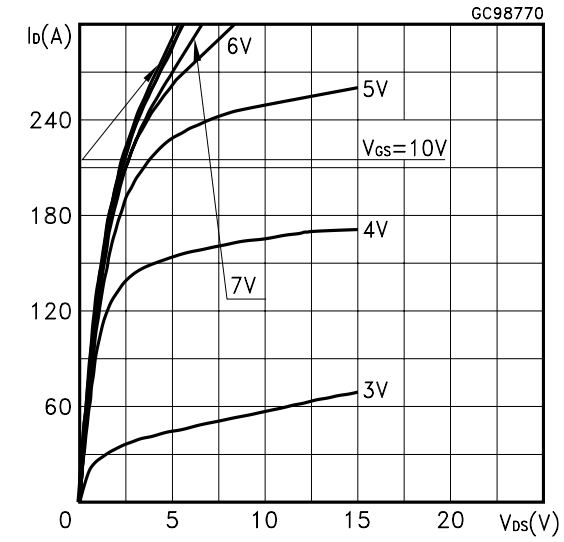
Safe Operating Area



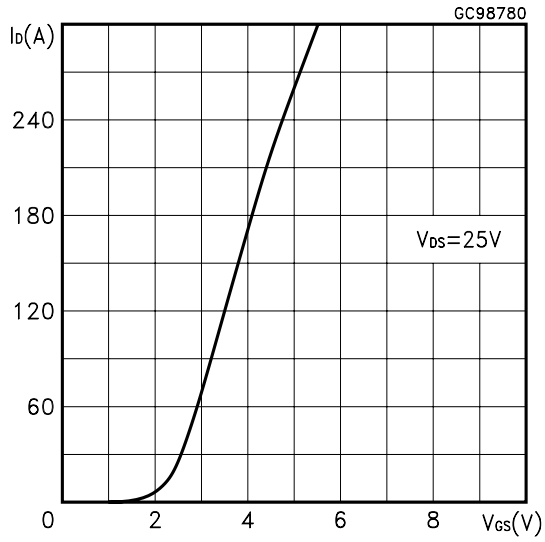
Thermal Impedance



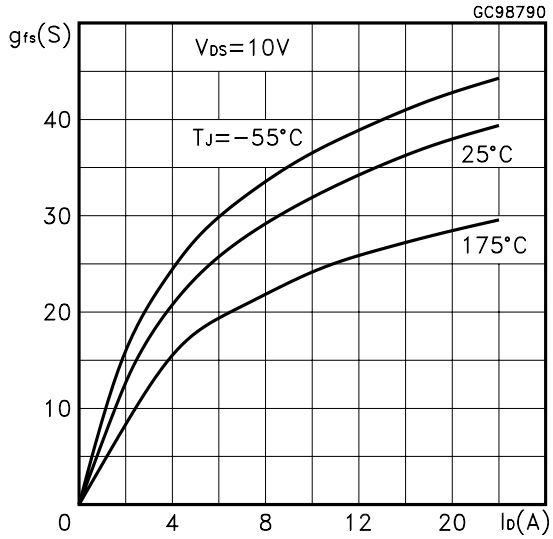
Output Characteristics



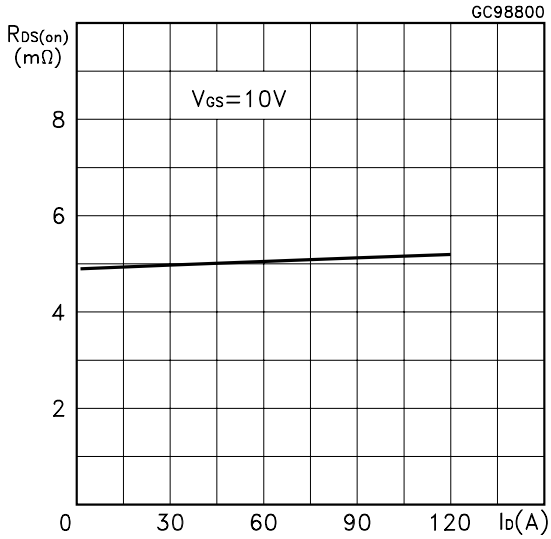
Transfer Characteristics



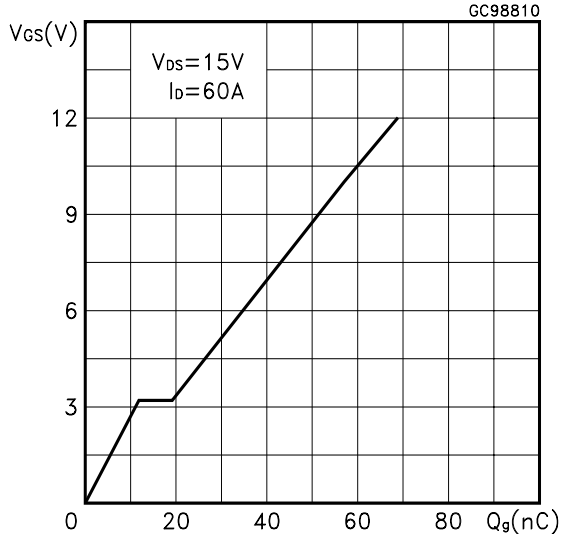
Transconductance



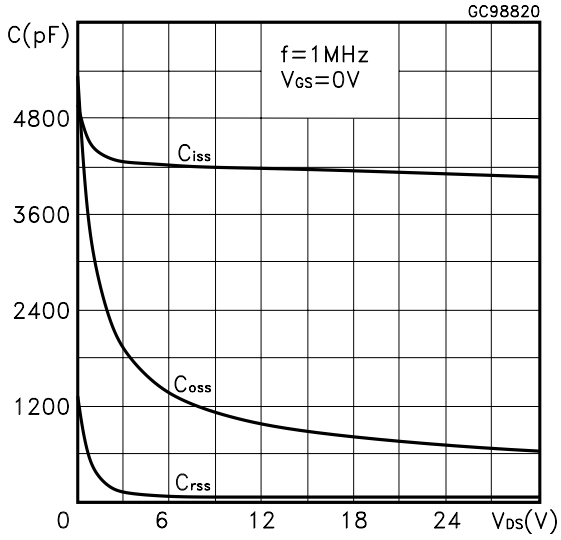
Static Drain-source On Resistance



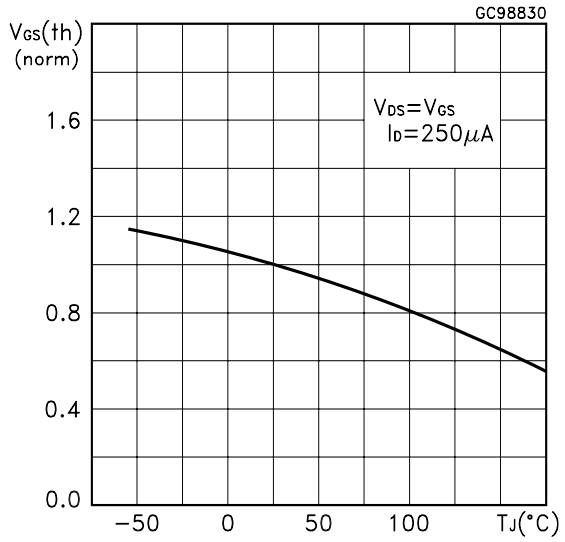
Gate Charge vs Gate-source Voltage



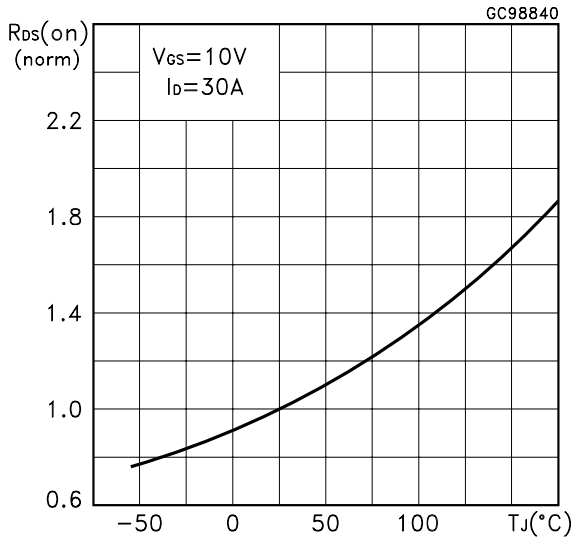
Capacitance Variations



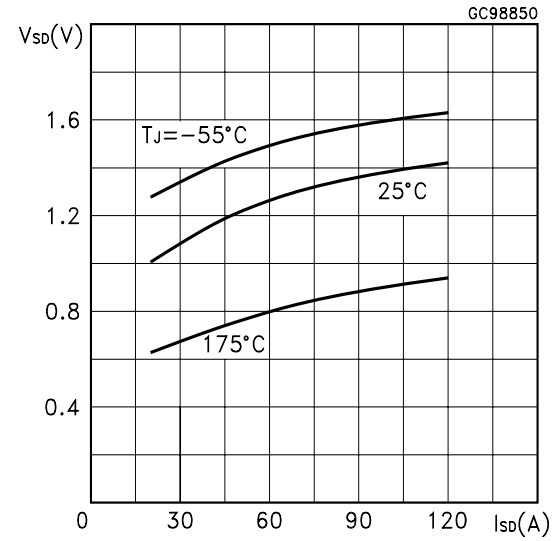
Normalized Gate Threshold Voltage vs Temperature



Normalized on Resistance vs Temperature

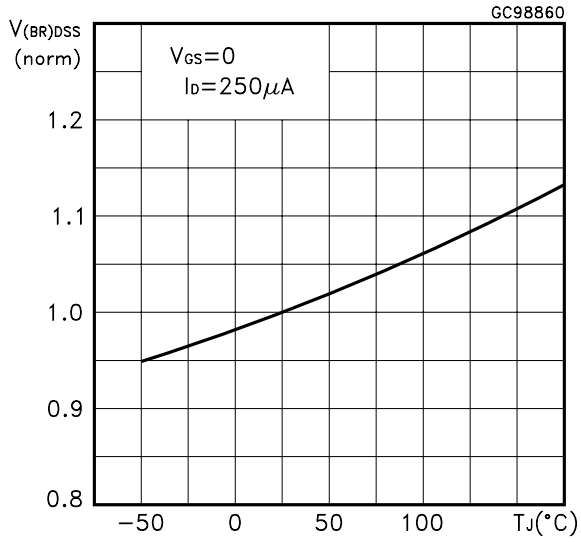


Source-drain Diode Forward Characteristics



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Normalized Breakdown Voltage vs Temperature



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Fig. 1: Unclamped Inductive Load Test Circuit

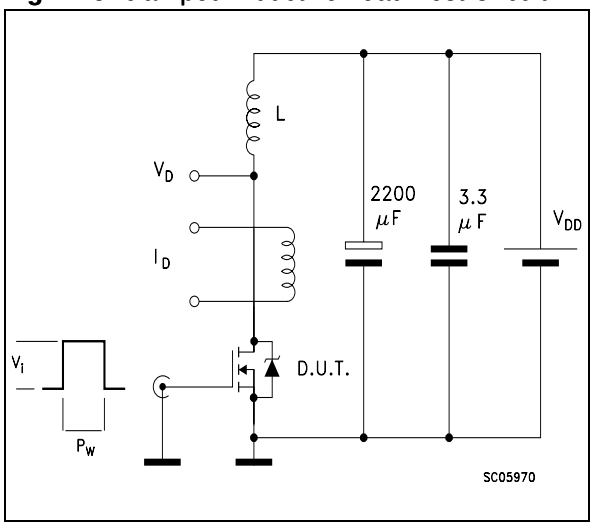


Fig. 2: Unclamped Inductive Waveform

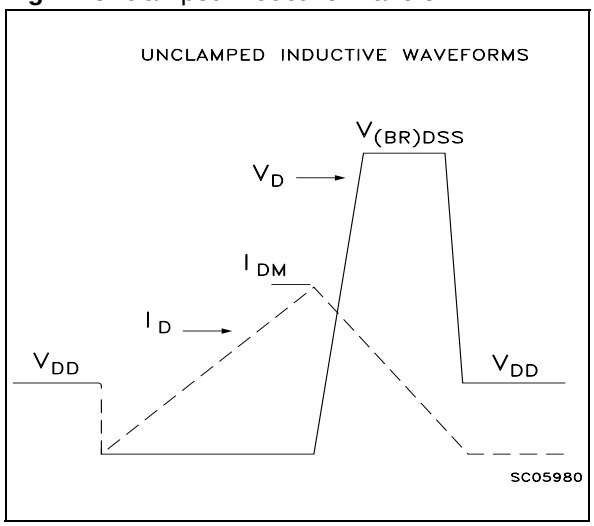


Fig. 3: Switching Times Test Circuits For Resistive Load

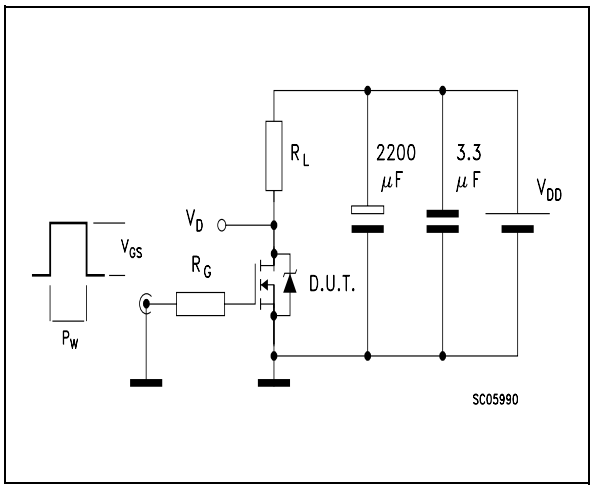


Fig. 4: Gate Charge test Circuit

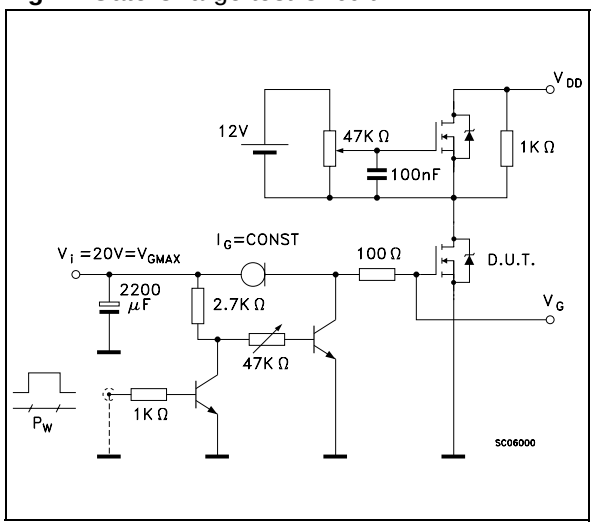
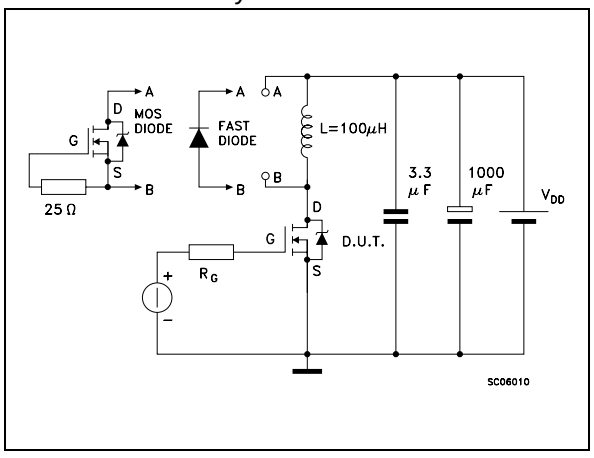
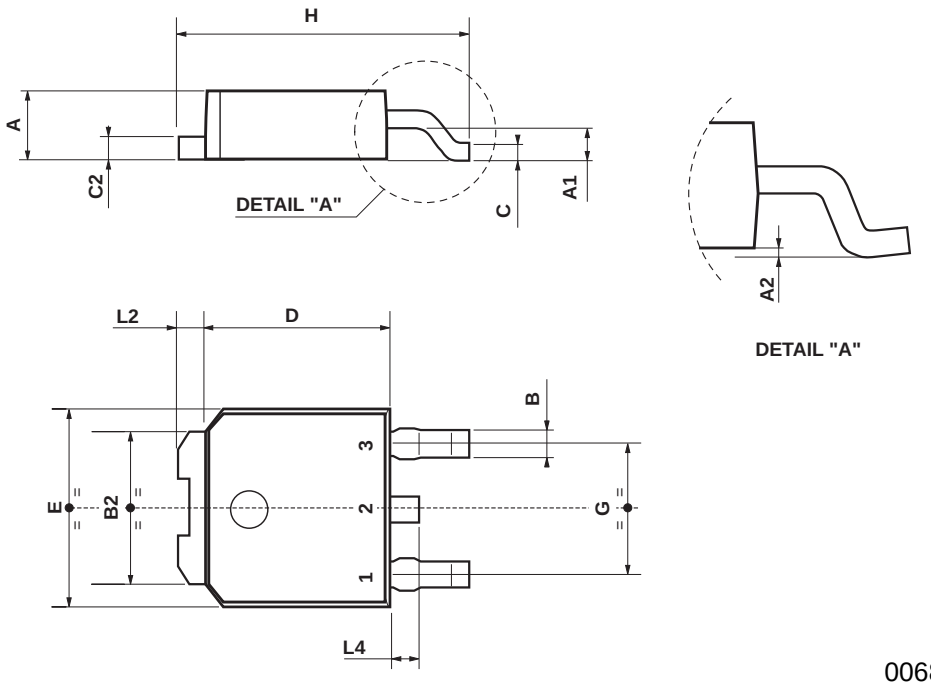


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times



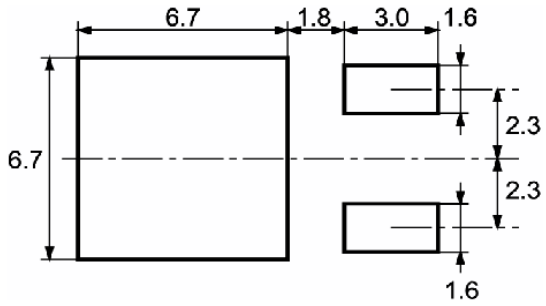
TO-252 (DPAK) MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	2.2		2.4	0.086		0.094
A1	0.9		1.1	0.035		0.043
A2	0.03		0.23	0.001		0.009
B	0.64		0.9	0.025		0.035
B2	5.2		5.4	0.204		0.212
C	0.45		0.6	0.017		0.023
C2	0.48		0.6	0.019		0.023
D	6		6.2	0.236		0.244
E	6.4		6.6	0.252		0.260
G	4.4		4.6	0.173		0.181
H	9.35		10.1	0.368		0.397
L2		0.8			0.031	
L4	0.6		1	0.023		0.039



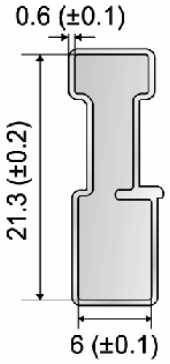
0068772-B

DPAK FOOTPRINT



All dimensions are in millimeters

TUBE SHIPMENT (no suffix)*



BASE QTY
75

BULK QTY
3000

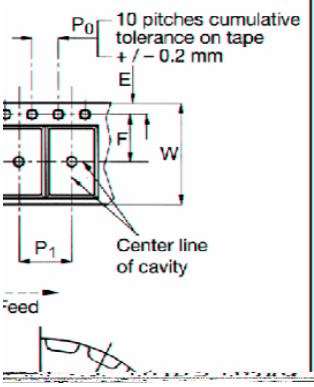
Tube length 532 (±0.5)

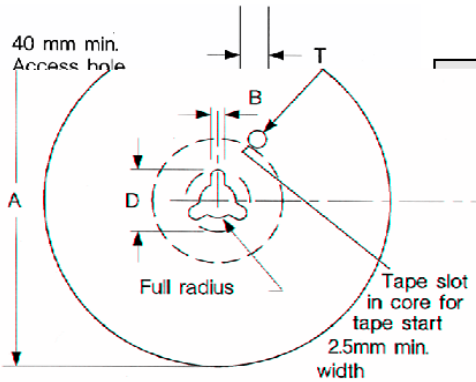
All dimensions are in millimeters

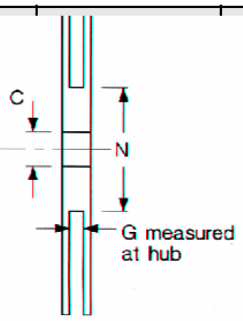
TAPE AND REEL SHIPMENT (suffix "T4")*

	330		12.992
		0.059	
	13.2	0.504	0.520
		0.795	
	18.4	0.645	0.724
		1.968	
	22.4		0.881

Y	BULK QTY
	1000







REEL MECHANICAL DATA

A	
B	1.5
C	12.8
D	20.2
G	16.4
N	50
T	

BASE QT
1000

TAPE MECHANICAL DATA

DIM.	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A0	6.8	7	0.267	0.275
B0	10.4	10.6	0.409	0.417
B1		12.1		0.476
D	1.5	1.6	0.059	0.063
D1	1.5		0.059	
E	1.65	1.85	0.065	0.073
F	7.4	7.6	0.291	0.299
K0	2.55	2.75	0.100	0.108
P0	3.9	4.1	0.153	0.161

